

STGW50NB60H

N-CHANNEL 50A - 600V TO-247 PowerMESHTM IGBT

PRELIMINARY DATA

TYPE	V _{CES}	V _{CE(sat)}	I _C	
STGW50NB60H	600 V	< 2.8 V	50 A	

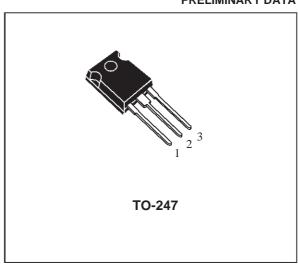
- HIGH INPUT IMPEDANCE (VOLTAGE DRIVEN)
- LOW ON-VOLTAGE DROP (VCESAT)
- LOW GATE CHARGE
- HIGH CURRENT CAPABILITY
- VERY HIGH FREQUENCY OPERATION
- OFF LOSSES INCLUDE TAIL CURRENT

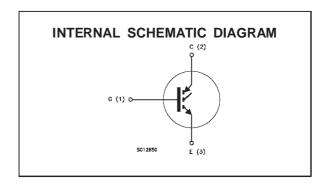
DESCRIPTION

Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESHTM IGBTs, with outstanding perfomances. The suffix "H" identifies a family optimized to achieve very low switching times for high frequency applications (<120kHz).

APPLICATIONS

- HIGH FREQUENCY MOTOR CONTROLS
- WELDING EQUIPMENTS
- SMPS AND PFC IN BOTH HARD SWITCH AND RESONANT TOPOLOGIES





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CES}	Collector-Emitter Voltage (V _{GS} = 0)	600	V
V _{ECR}	Emitter-Collector Voltage	20	V
V_{GE}	Gate-Emitter Voltage	± 20	V
Ic	Collector Current (continuous) at T _c = 25 °C	100	Α
Ic	Collector Current (continuous) at T _c = 100 °C	50	Α
I _{CM} (•)	Collector Current (pulsed)	400	Α
P _{tot}	Total Dissipation at T _c = 25 °C	250	W
	Derating Factor	2	W/°C
T _{stg}	Storage Temperature	-65 to 150	°C
Tj	Max. Operating Junction Temperature	150	°C

(•) Pulse width limited by safe operating area

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THERMAL DATA

R _{thj}	-case	Thermal	Resistance	Junction-case	Max	0.5	°C/W
R _{thi}	j-amb	Thermal	Resistance	Junction-ambient	Max	30	oC/W
Rth	hc-h	Thermal	Resistance	Case-heatsink	Тур	0.1	°C/W

ELECTRICAL CHARACTERISTICS ($T_j = 25$ $^{\circ}C$ unless otherwise specified)

OFF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{BR(CES)}	Collector-Emitter Breakdown Voltage	$I_C = 250 \ \mu A$ $V_{GE} = 0$	600			V
I _{CES}	Collector cut-off (V _{GE} = 0)	$V_{CE} = Max Rating$ $T_j = 25 ^{\circ}C$ $V_{CE} = Max Rating$ $T_j = 125 ^{\circ}C$			10 100	μA μA
I _{GES}	Gate-Emitter Leakage Current (V _{CE} = 0)	$V_{GE} = \pm 20 \text{ V}$ $V_{CE} = 0$			± 100	nA

ON (*)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{GE(th)}	Gate Threshold Voltage	$V_{CE} = V_{GE}$ $I_C = 250 \mu A$	3		5	V
VCE(SAT)	Collector-Emitter Saturation Voltage	$V_{GE} = 15 \text{ V}$ $I_{C} = 50 \text{ A}$ $V_{GE} = 15 \text{ V}$ $I_{C} = 50 \text{ A}$ $T_{j} = 125 ^{\circ}\text{C}$		2.3 1.9	2.8	V V

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
G fs	Forward Transconductance	V _{CE} =25 V I _C = 50 A		22		S
C _{ies} C _{oes} C _{res}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	V _{CE} = 25 V f = 1 MHz V _{GE} = 0		4500 450 90		pF pF pF
Q _G Q _{GE} Q _{GC}	Total Gate Charge Gate-Emitter Charge Gate-Collector Charge	V _{CE} = 480 V I _C = 50 A V _{GE} = 15 V		260 28 115		nC nC nC
I _{CL}	Latching Current	$V_{clamp} = 480 \text{ V}$ $R_{G} = 10 \Omega$ $T_{j} = 150 ^{\circ}\text{C}$	200			А

SWITCHING ON

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
t _{d(on)}	Delay Time Rise Time	V _{CC} = 480 V V _{GE} = 15 V	$I_C = 50 A$ $R_G = 10\Omega$		30 90		ns ns
(di/dt) _{on}	Turn-on Current Slope	$V_{CC} = 480 \text{ V}$ $R_G = 10 \Omega$	$I_{C} = 50 \text{ A}$ $V_{GE} = 15 \text{ V}$		350		A/μs
Eon	Turn-on Switching Losses	T _j = 125 °C			600		μJ

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ELECTRICAL CHARACTERISTICS (continued)

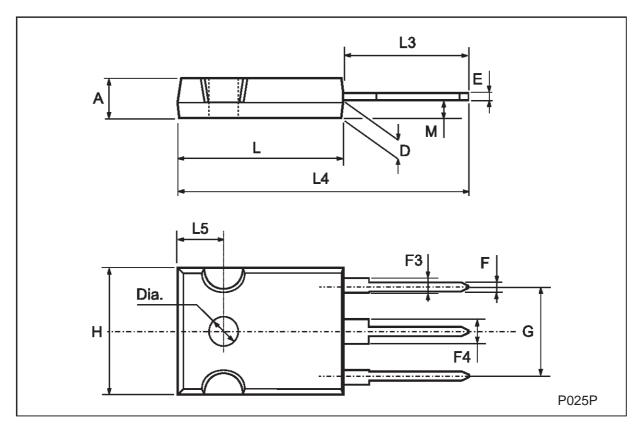
SWITCHING OFF

Symbol	Parameter	Test Co	nditions	Min.	Тур.	Max.	Unit
tc	Cross-Over Time	V _{CC} = 480 V	$I_C = 50 A$		166		ns
$t_r(v_{off})$	Off Voltage Rise Time	$R_{GE} = 10 \Omega$	$V_{GE} = 15 V$		48		ns
t _d (off)	Delay Time				326		ns
t _f	Fall Time				90		ns
E _{off} (**)	Turn-off Switching Loss				2.1		mJ
E _{ts}	Total Switching Loss				2.7		mJ
tc	Cross-Over Time	VCC = 480 V	$I_{\rm C} = 50 {\rm A}$		270		ns
$t_r(v_{off})$	Off Voltage Rise Time	$R_{GE} = 10 \Omega$	$V_{GE} = 15 V$		75		ns
t _d (off)	Delay Time	T _j = 125 °C			340		ns
t _f	Fall Time				200		ns
E _{off} (**)	Turn-off Switching Loss				2.9		mJ
E _{ts}	Total Switching Loss				3.5		mJ

^(*) Pulse width limited by max. junction temperature
(*) Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %
(**)Losses Include Also The Tail (Jedec Standardization)

TO-247 MECHANICAL DATA

DIM.		mm			inch	
Diwi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	4.7		5.3	0.185		0.209
D	2.2		2.6	0.087		0.102
Е	0.4		0.8	0.016		0.031
F	1		1.4	0.039		0.055
F3	2		2.4	0.079		0.094
F4	3		3.4	0.118		0.134
G		10.9			0.429	
Н	15.3		15.9	0.602		0.626
L	19.7		20.3	0.776		0.779
L3	14.2		14.8	0.559		0.582
L4		34.6			1.362	
L5		5.5			0.217	
М	2		3	0.079		0.118



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